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SEMICONDUCTOR®

November 2013

FQD19N10

N-Channel QFET[®] MOSFET

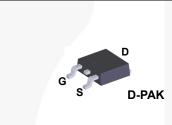
100 V, 15.6 A, 100 mΩ

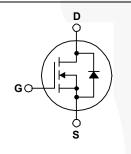
Description

This N-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, audio amplifier, DC motor control, and variable switching power applications.

Features

- 15.6 A, 100 V, $\rm R_{DS(on)}$ = 100 m Ω (Max.) @ V_{GS} = 10 V, $\rm I_{D}$ = 7.8 A
- Low Gate Charge (Typ. 19 nC)
- Low Crss (Typ. 32 pF)
- 100% Avalanche Tested





Absolute Maximum Ratings T_c = 25°C unless otherwise noted.

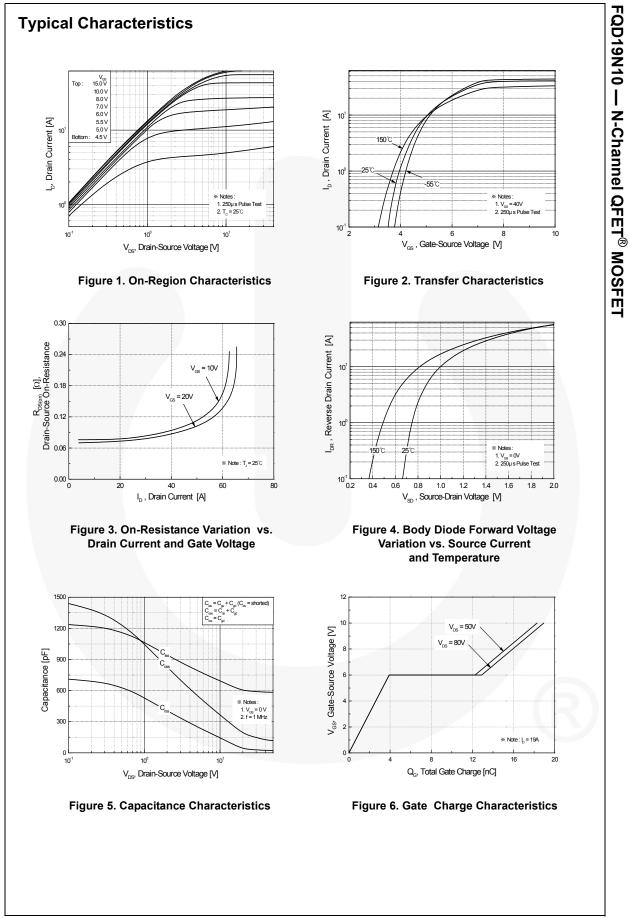
Symbol	Parameter			FQD19N10TM	Unit	
V _{DSS}	Drain-Source V	in-Source Voltage		100	V	
I _D	Drain Current	- Continuous (T _C = 25°	°C)	15.6	A	
		- Continuous (T _C = 100°C)		9.8	A	
I _{DM}	Drain Current	- Pulsed	(Note 1)	62.4	A	
V _{GSS}	Gate-Source Voltage			± 25	V	
E _{AS}	Single Pulsed Avalanche Energy		(Note 2)	220	mJ	
I _{AR}	Avalanche Curr	rent	(Note 1)	15.6	A	
E _{AR}	Repetitive Avalanche Energy		(Note 1)	5.0	mJ	
dv/dt	Peak Diode Re	covery dv/dt	(Note 3)	6.0	V/ns	
P _D	Power Dissipation ($T_A = 25^{\circ}C$) *			2.5	W	
	Power Dissipati	ion (T _C = 25°C)		50	W	
	- Derate above 25°C			0.4	W/°C	
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C	
TL	Maximum Lead 1/8" from Case	Temperature for Solderin for 5 Seconds	ng,	300	°C	

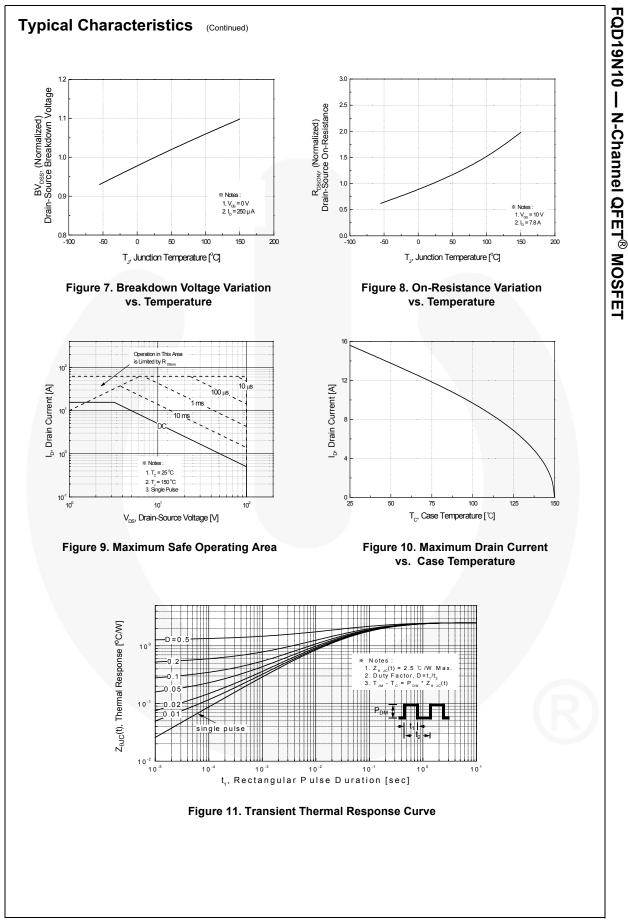
Thermal Characteristics

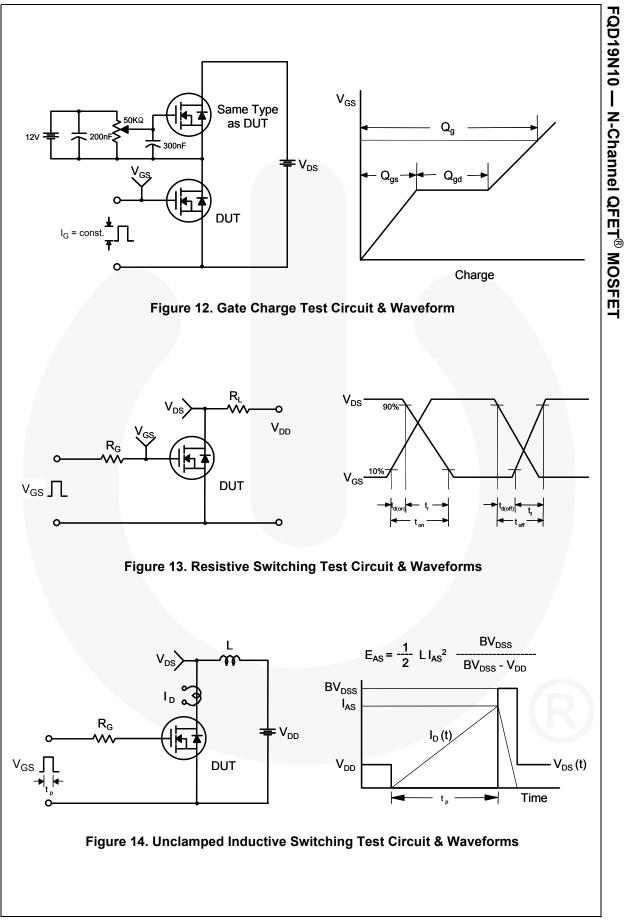
Symbol	Parameter	FQD19N10TM	Unit
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	2.5	
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient (Minimum Pad of 2-oz Copper), Max.	110	°C/W
	Thermal Resistance, Junction to Ambient (*1 in ² Pad of 2-oz Copper), Max.	50	

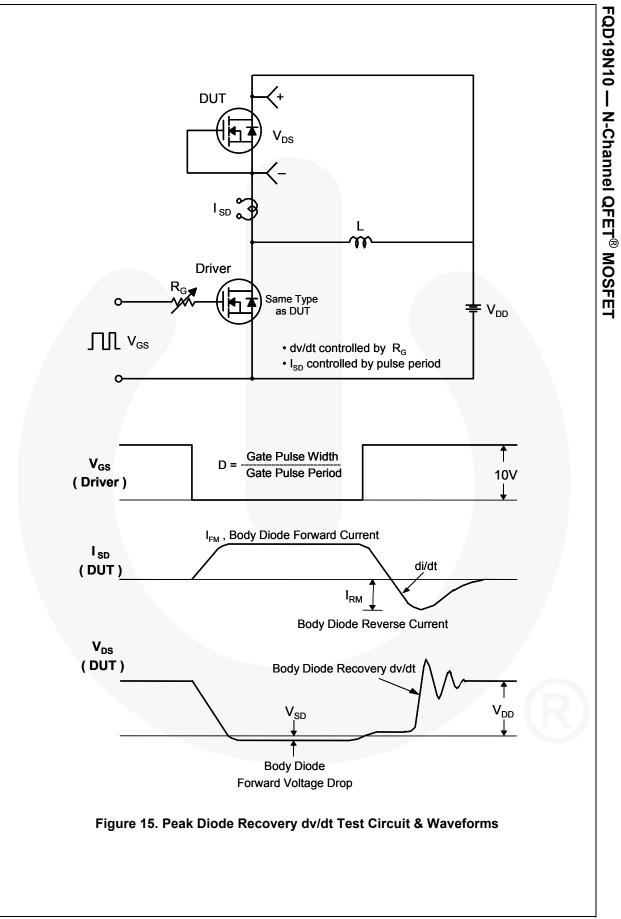
		Top Mark	Pack	age Pac	Packing Method	Reel	Size	Tape Width		Quantity	
		D-P	PAK Tape and Reel 330		mm	16 mm		2500 units			
lectri	cal Cha	racteristics	Γ _c = 25°C un	less otherv	vise noted.						
Symbol		Parameter			Test Conditions		Min.	Тур.	Max.	Unit	
	racterist	ice									
BV _{DSS}		Irce Breakdown Volt	200	Voo =	0 V, I _D = 250 μA		100			V	
ABV _{DSS}		n Voltage Temperat	•				100			v	
$\Delta T_{\rm I}$	Coefficien	•	ure	I _D = 2	50 μA, Referenced to	o 25°C		0.1		V/°C	
DSS				V _{DS} =	100 V, V _{GS} = 0 V				1	μA	
	Zero Gate	e Voltage Drain Curr	ent	V _{DS} =	80 V, T _C = 125°C				10	μA	
GSSF	Gate-Bod	y Leakage Current,	Forward		25 V, V _{DS} = 0 V				100	nA	
GSSR	Gate-Bod	y Leakage Current,	Reverse	V _{GS} =	-25 V, V _{DS} = 0 V				-100	nA	
	1										
	racterist	ics		1			1	1			
/ _{GS(th)}		shold Voltage		V _{DS} =	V_{GS} , $I_D = 250 \ \mu A$		2.0		4.0	V	
₹DS(on)	Static Dra On-Resist				10 V, I _D = 7.8 A			0.078	0.1	Ω	
JFS	Forward Transconductance			V _{DS} =	40 V, I _D = 7.8 A			11		S	
_											
		cteristics		-					700	-	
C _{iss}	Input Cap				$25 V, V_{GS} = 0 V,$			600	780	pF	
C _{oss} C _{rss}	Output Ca	ransfer Capacitance		f = 1.0) MHz			165 32	215 40	pF pF	
Switchi	ng Chara	acteristics									
d(on)		Delay Time	_	V -	50 V = 10 A			7.5	25	ns	
r	Turn-On F	Rise Time	_	$R_{G} = 2$	50 V, I _D = 19 A,			150	310	ns	
d(off)	Turn-Off D	Delay Time		ing i	20 32			20	50	ns	
f	Turn-Off F	all Time				(Note 4)		65	140	ns	
ე ^g	Total Gate	e Charge		V _{DS} =	80 V, I _D = 19 A,			19	25	nC	
ସୁ _{gs}	Gate-Sou	rce Charge		V _{GS} =	10 V			3.9		nC	
ე _{gd}	Gate-Drai	n Charge				(Note 4)		9.0		nC	
			_								
	I				-		1	[-		
-											
-											
			voltage							V	
		,		00	•						
	Reverse F	Recovery Charge		ui _F / u	ι – 100 Α/μs			200		nC	
Drain-S Is I _{SM} V _{SD}	ource Di Maximum Maximum Drain-Sou	ode Characteri Continuous Drain-S Pulsed Drain-Sourc irce Diode Forward	Source Dic ce Diode F	ode Forv Forward V _{GS} =	Current 0 V, I _S = 15.6 A	(Note 4)			15.6 62.4 1.5		
m	Reverse F	Recovery Time		V _{GS} =	0 V, I _S = 19 A,			78	1	ns	
ୁ nr otes:	Reverse F	Recovery Charge		ai ^E / a	t = 100 A/μs			200		nC	
L = 1.35 mH I _{SD} ≤ 19 A, c	l, I _{AS} = 15.6 A, ^v li/dt ≤ 300 A/µs	tth limited by maximum jut $V_{DD} = 25 V$, $R_G = 25 \Omega$, st , $V_{DD} \le BV_{DSS}$, starting $T_J =$ operating temperature.	arting T _J = 2								

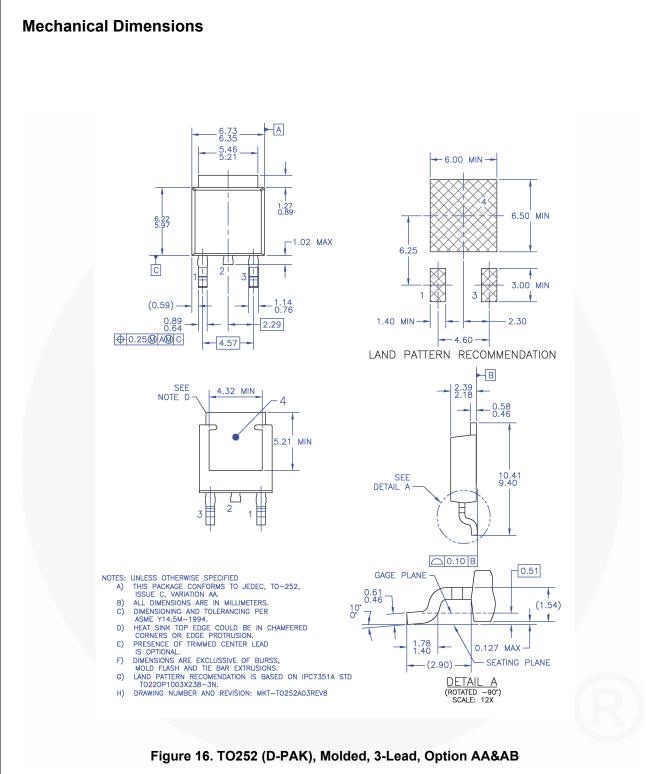
FQD19N10 — N-Channel QFET[®] MOSFET











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http://www.fairchildsemi.com/package/packageDetails.html?id=PN_TT252-003

FQD19N10 — N-Channel QFET[®] MOSFET



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FQD19N10 Rev. C1

Rev. 166

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